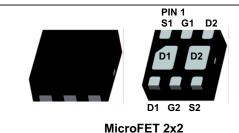


FDMA1028NZ

Dual N-Channel PowerTrench[®] MOSFET

General Description

This device is designed specifically as a single package solution for dual switching requirements in cellular handset and other ultra-portable applications. It features two independent N-Channel MOSFETs with low on-state resistance for minimum conduction losses. The MicroFET 2x2 package offers exceptional thermal performance for its physical size and is well suited to linear mode applications.

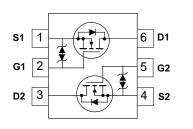


Features

- 3.7 A, 20V. $R_{DS(ON)} = 68 \text{ m}\Omega @ V_{GS} = 4.5V$ $R_{DS(ON)} = 86 \text{ m}\Omega @ V_{GS} = 2.5V$
- Low profile 0.8 mm maximum in the new package MicroFET 2x2 mm

October 2010

- HBM ESD protection level > 2kV (Note 3)
- RoHS Compliant
- Free from halogenated compounds and antimony oxides



Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter			Ratings	Unit
V _{DS}	Drain-Sourc	e Voltage		20	V
V _{GS}	Gate-Sourc	e Voltage		±12	V
ID	Drain Current – Continuous		(Note 1a)	3.7	A
		– Pulsed		6	
PD	Power Dissipation for Single Operation (N		ON (Note 1a)	1.4	W
			(Note 1b)	0.7	
T _J , T _{STG}	Operating a	nd Storage Junction Tem	perature Range	-55 to +150	°C
			biopt (1) (1)	96 (Single Operation)	
R _{0JA}	Thermal Re	teristics sistance, Junction-to-Aml sistance, Junction-to-Aml		86 (Single Operation) 173 (Single Operation)	
	Thermal Re Thermal Re	sistance, Junction-to-Amb	bient (Note 1b)	173 (Single Operation) 69 (Dual Operation)	
R _{θJA} R _{θJA}	Thermal Re Thermal Re Thermal Re	sistance, Junction-to-Amb sistance, Junction-to-Amb	bient (Note 1b) bient (Note 1c)	173 (Single Operation)	•C/W
R _{0JA} R _{0JA} R _{0JA} R _{0JA}	Thermal Re Thermal Re Thermal Re Thermal Re	sistance, Junction-to-Aml sistance, Junction-to-Aml sistance, Junction-to-Aml	bient (Note 1b) bient (Note 1c) bient (Note 1d)	173 (Single Operation) 69 (Dual Operation)	°C/W
R _{0JA} R _{0JA} R _{0JA} R _{0JA}	Thermal Re Thermal Re Thermal Re Thermal Re e Markin	sistance, Junction-to-Aml sistance, Junction-to-Aml sistance, Junction-to-Aml sistance, Junction-to-Aml	bient (Note 1b) bient (Note 1c) bient (Note 1d)	173 (Single Operation) 69 (Dual Operation)	C/W

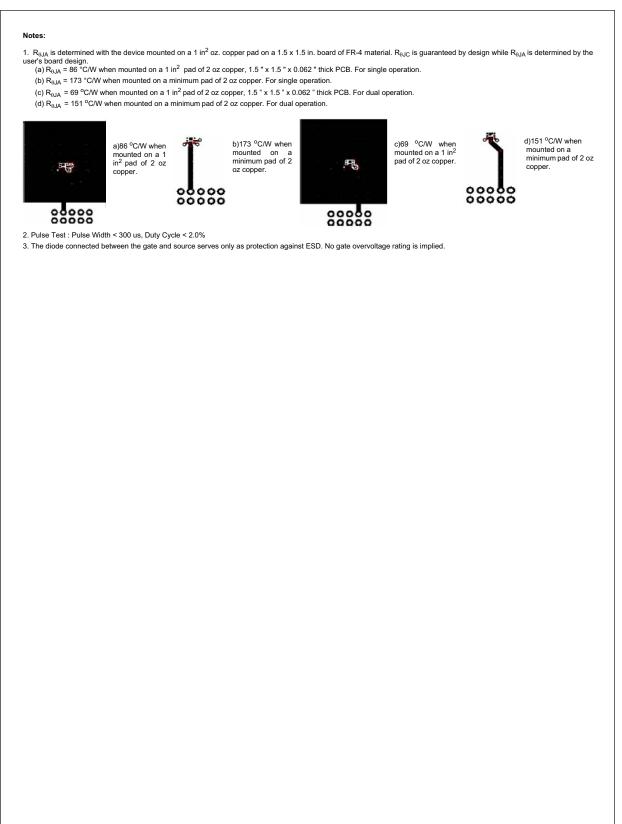
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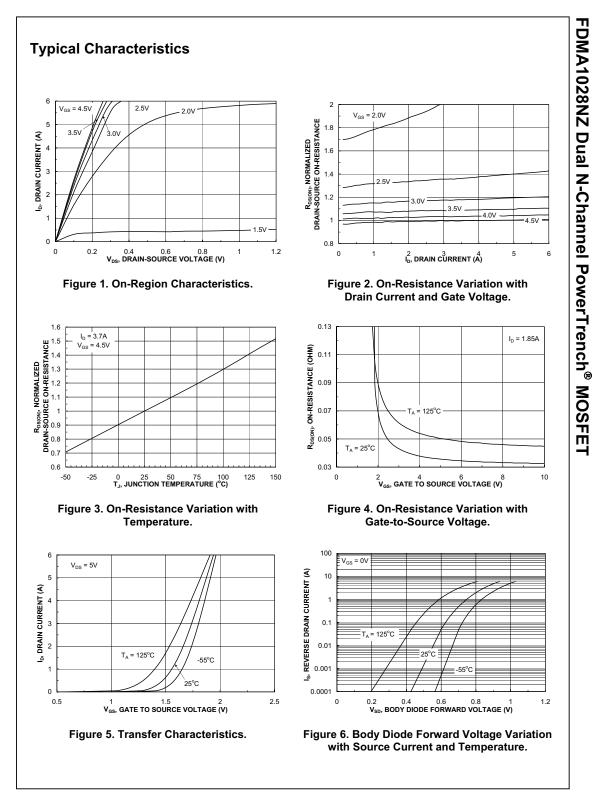
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = 250 \mu A$	20			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		15		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 16 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate-Body Leakage	$V_{GS} = \pm 12 V$, $V_{DS} = 0 V$			±10	μA
On Chara	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	0.6	1.0	1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		-4		mV/°C
R _{DS(on)}	Static Drain–Source	$V_{GS} = 4.5 \text{ V}, I_D = 3.7 \text{ A}$		37	68	mΩ
	On–Resistance	$V_{GS} = 2.5 V, I_D = 3.3 A$		50 53	86 90	
	E	V_{GS} = 4.5 V, I_D = 3.7 A, T_J =125°C	-		90	
g _{FS}	Forward Transconductance	$V_{DS} = 10 \text{ V}, I_D = 3.7 \text{ A}$		16		S
Dynamic	Characteristics					
Ciss	Input Capacitance	$V_{DS} = 10 V$, $V_{GS} = 0 V$,		340		pF
Coss	Output Capacitance	f = 1.0 MHz		80		pF
C _{rss}	Reverse Transfer Capacitance			60		pF
Rg	Gate Resistance		0.1	4	12	Ω
Switchin t _{d(on)}	g Characteristics (Note 2)	$V_{DD} = 10 V$, $I_D = 1 A$,		8	16	ns
t,	Turn–On Rise Time	V_{GS} = 4.5 V, R_{GEN} = 6 Ω		8	16	ns
t _{d(off)}	Turn–Off Delay Time	1		14	26	ns
t _f	Turn–Off Fall Time	1		3	6	ns
Q _g	Total Gate Charge	$V_{DS} = 10 \text{ V}, I_D = 3.7 \text{ A},$		4	6	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 4.5 V		0.7		nC
Q _{gd}	Gate-Drain Charge	1		1.1		nC

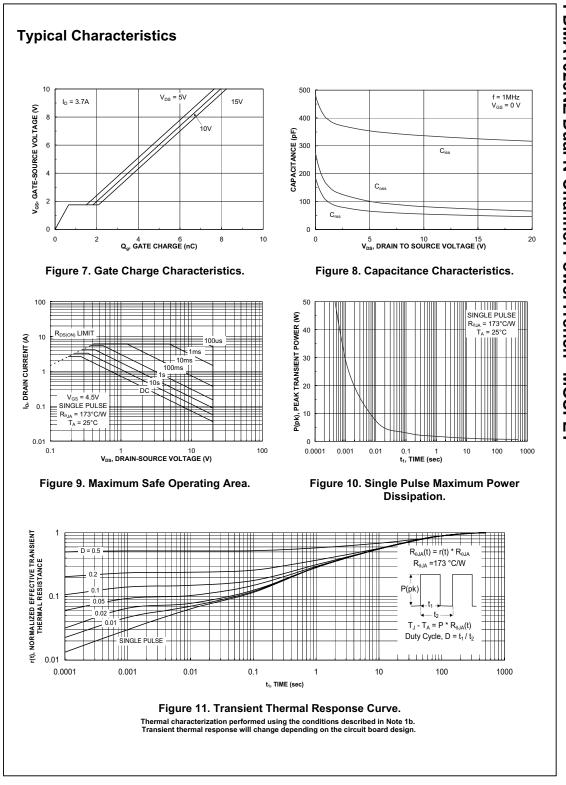
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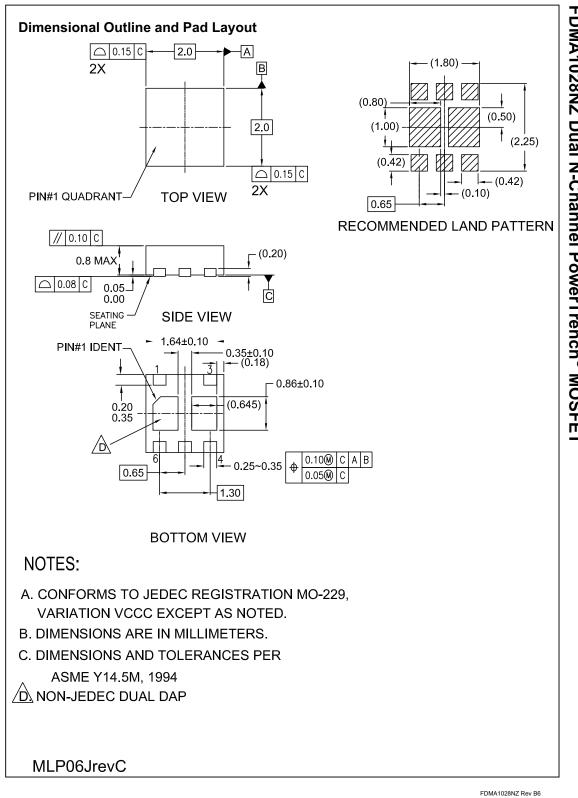
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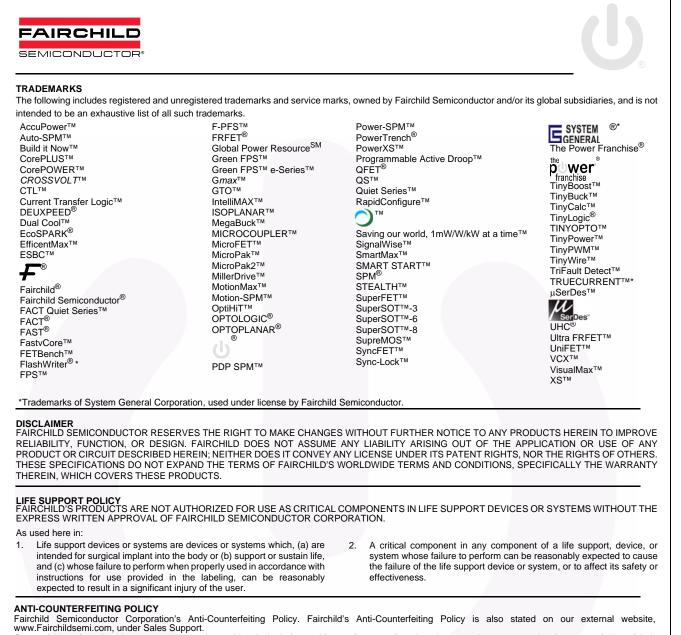




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No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
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